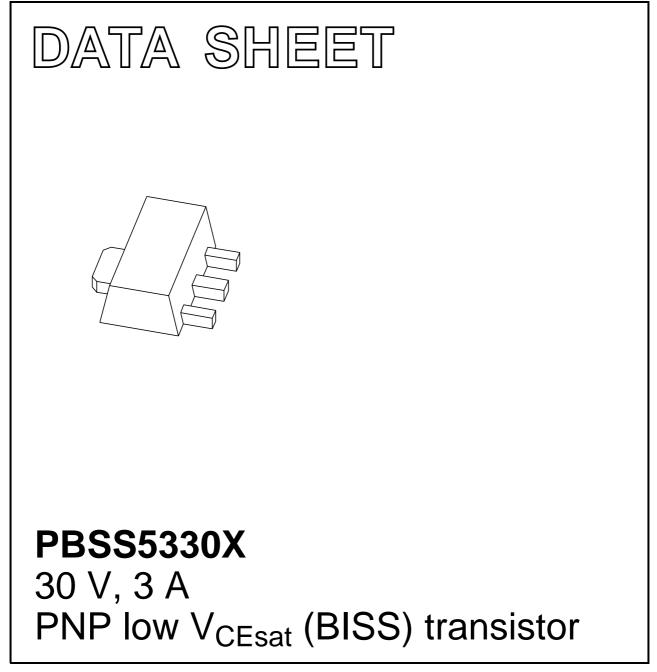
DISCRETE SEMICONDUCTORS



Product data sheet Supersedes data of 2003 Nov 28 2004 Nov 03



PBSS5330X

30 V, 3 A PNP low V_{CEsat} (BISS) transistor

FEATURES

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage V_{CEsat}
- High collector current capability: I_C and I_{CM}
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

APPLICATIONS

- Power management
 - DC/DC converters
 - Supply line switching
 - Battery charger
 - LCD backlighting.
- Peripheral drivers
 - Driver in low supply voltage applications (e.g. lamps and LEDs)
 - Inductive load driver (e.g. relays, buzzers and motors).

DESCRIPTION

PNP low V_{CEsat} transistor in a SOT89 plastic package.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS5330X	*1S

Note

- 1. * = p: Made in Hong Kong.
 - * = t: Made in Malaysia.
 - * = W: Made in China.

ORDERING INFORMATION

TYPE NUMBER	PACKAGE				
NAME DESCRIPTION		DESCRIPTION	VERSION		
PBSS5330X	SC-62	SC-62 plastic surface mounted package; collector pad for good heat transfer; 3 leads			

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V _{CEO}	collector-emitter voltage	-30	V
I _C	collector current (DC) –3		А
I _{CM}	peak collector current -5		А
R _{CEsat}	equivalent on-resistance 107		mΩ

PINNING

PIN	DESCRIPTION	
1	emitter	
2	collector	
3	base	

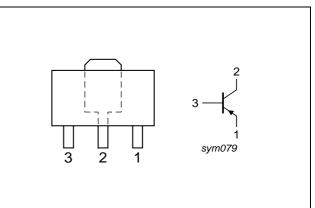


Fig.1 Simplified outline (SOT89) and symbol.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	-	-30	V
V _{CEO}	collector-emitter voltage	open base	—	-30	V
V _{EBO}	emitter-base voltage	open collector	—	-6	V
I _C	collector current (DC)	note 4	-	-3	A
I _{CM}	peak collector current	limited by T _{j(max)}	-	-5	А
I _B	base current (DC)		—	-0.5	A
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
		note 1	_	550	mW
		note 2	_	1	W
		note 3	_	1.4	W
		note 4	_	1.6	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-65	+150	°C

Notes

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.

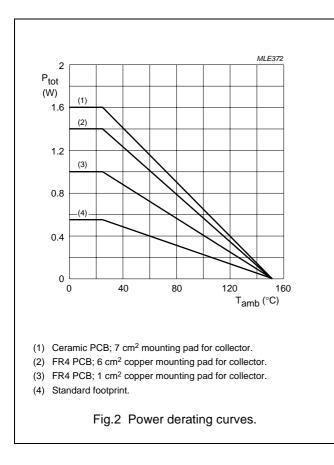
2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².

3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².

4. Device mounted on a ceramic printed-circuit board 7 cm², single-sided copper, tin-plated.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th(j-a)}	thermal resistance from junction to ambient	in free air		
		note 1	225	K/W
		note 2	125	K/W
		note 3	90	K/W
		note 4	80	K/W
R _{th(j-s)}	thermal resistance from junction to soldering point		16	K/W

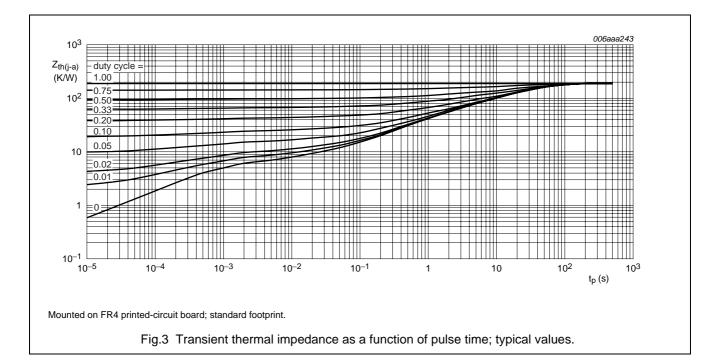
Notes

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.

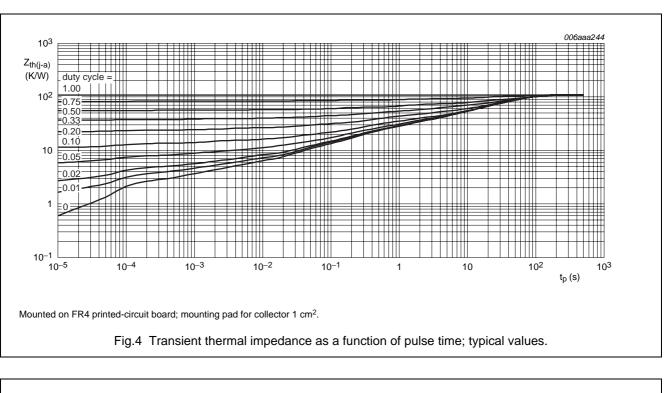
2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm².

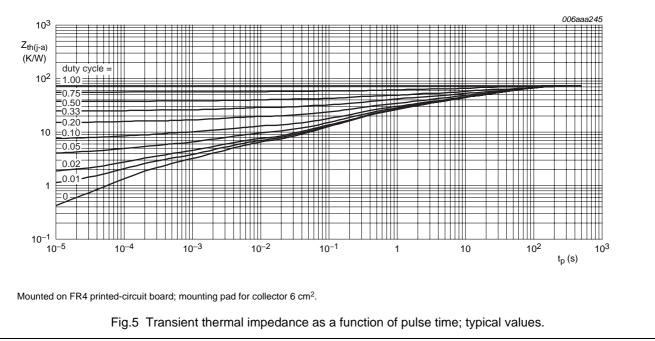
3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm².

4. Device mounted on a ceramic printed-circuit board 7 cm², single-sided copper, tin-plated.



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CHARACTERISTICS

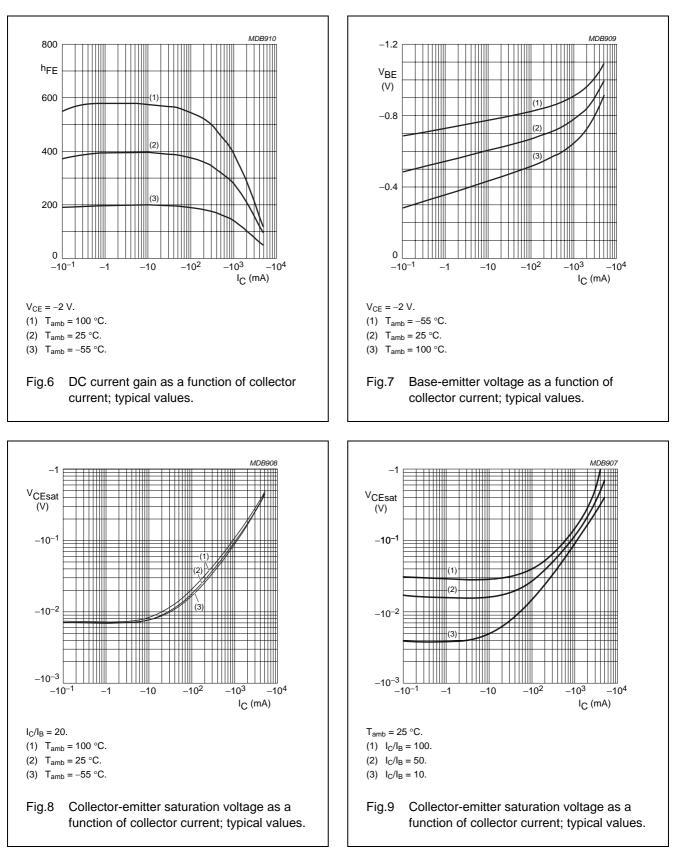
 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; \text{ I}_{E} = 0 \text{ A}$	-	-	-100	nA
		$V_{CB} = -30 \text{ V}; \text{ I}_{E} = 0 \text{ A}; \text{ T}_{j} = 150 ^{\circ}\text{C}$	-	-	-50	μA
I _{CES}	collector-emitter cut-off current	$V_{CE} = -30 \text{ V}; \text{ V}_{BE} = 0 \text{ V}$	-	-	-100	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -5 V; I_C = 0 A$	-	-	-100	nA
h _{FE}	DC current gain	$V_{CE} = -2 V$				
		$I_{\rm C} = -0.1 {\rm A}$	200	-	-	
		I _C = -0.5 A	200	-	-	
		I _C = −1 A; note 1	175	-	450	
		I _C = −2 A; note 1	140	-	-	
		I _C = -3 A; note 1	100	-	-	
V _{CEsat}	collector-emitter saturation	$I_{\rm C} = -0.5 \text{ A}; I_{\rm B} = -50 \text{ mA}$	-	-	-70	mV
	voltage	$I_{\rm C} = -1$ A; $I_{\rm B} = -50$ mA	-	-	-130	mV
		$I_{\rm C} = -2$ A; $I_{\rm B} = -100$ mA	-	-	-240	mV
		$I_{C} = -3 \text{ A}; I_{B} = -300 \text{ mA}; \text{ note } 1$	-	-	-320	mV
R _{CEsat}	equivalent on-resistance	$I_{\rm C} = -3$ A; $I_{\rm B} = -300$ mA; note 1	-	80	107	mΩ
V _{BEsat}	base-emitter saturation voltage	$I_{\rm C} = -2$ A; $I_{\rm B} = -100$ mA	-	-	-1.1	V
		$I_{C} = -3 \text{ A}; I_{B} = -300 \text{ mA}; \text{ note } 1$	-	-	-1.2	V
V _{BEon}	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; \text{ I}_{C} = -1 \text{ A}$	-1.0	-	-	V
f _T	transition frequency	$I_{C} = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	_	_	MHz
C _c	collector capacitance	$V_{CB} = -10 \text{ V}; \text{ I}_{E} = \text{i}_{e} = 0 \text{ A}; \text{ f} = 1 \text{ MHz}$	-	-	45	pF

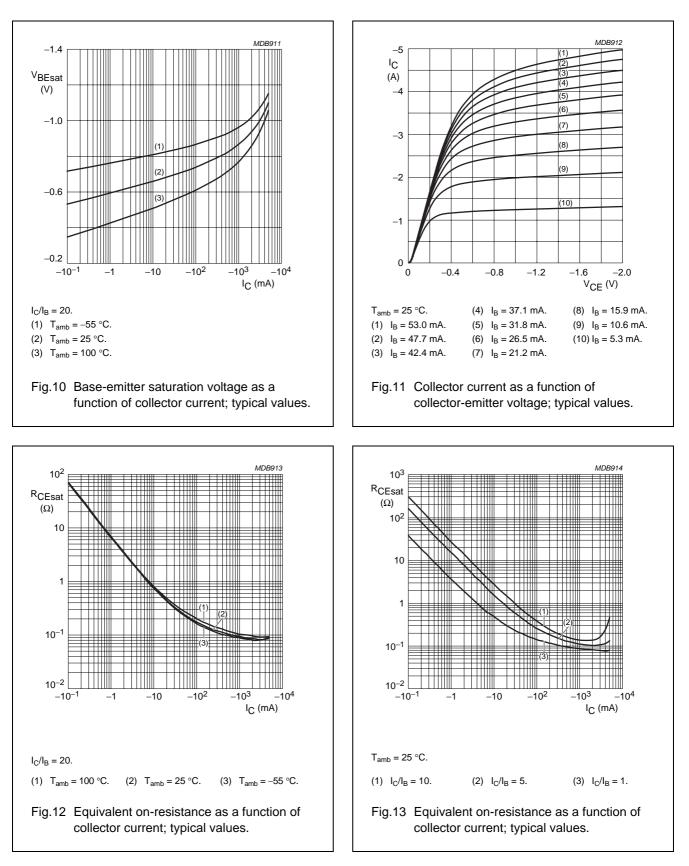
Note

1. Pulse test: $t_p \leq 300~\mu s;~\delta \leq 0.02.$

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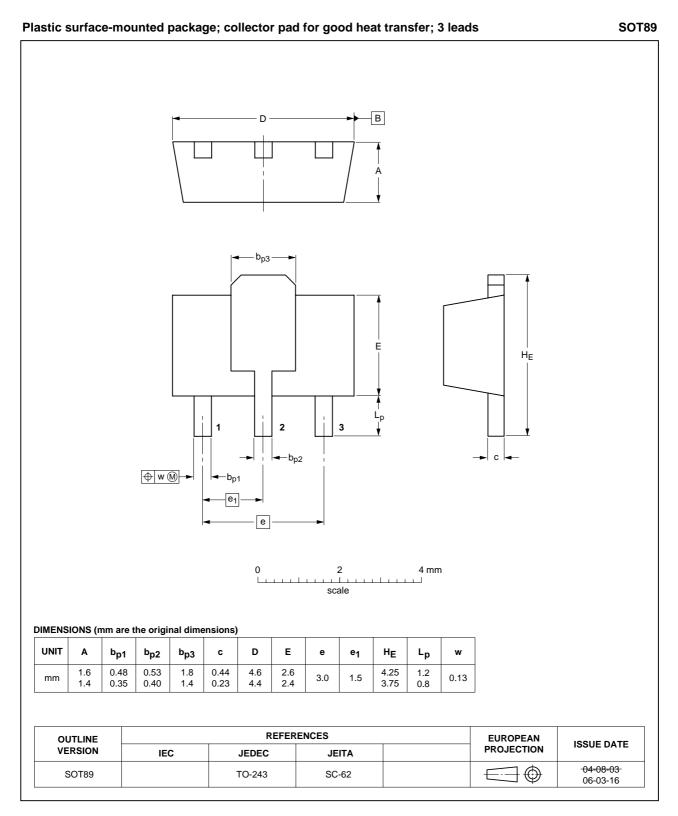
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PACKAGE OUTLINE



PBSS5330X

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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